#### **Features and Benefits**

10MHz Clipped Sine Wave VCTCXO 3.3V Supply +/- 1.5 ppm stability over -40°C to +85°C 2.5mm x 2.0mm x 0.9mm package SMD Ceramic Enclosure

## **TypicalApplications**

Wireless Communications GPS Base Stations Point-to-Point Radios

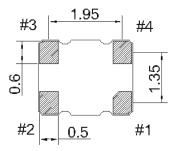
Broadband Access Test Equipment Handsets

#### **Description**

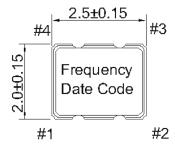
The TCXO2520 family offers low noise compensation techniques combined with aggressive conditioning processes resulting in outstanding long term stability, tightly distributed performance parameters, and superior long term reliability.

### **Mechanical Drawing & Pin Connections**

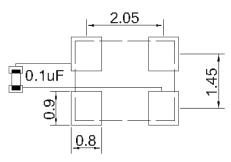




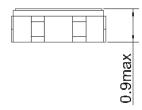
Top View



Recommended Pad Layout



Side	View
Oluc	A ICAR



Pin#	Function			
1	TCXO Control Voltage			
2	Electrical and case			
	ground			
3	Output Frequency			
4	Supply Voltage			

Unit: mm

# **Specifications**

Oscillator Specification		Sym	Condition	Min.	Value Typ.	Max.	Unit	Note		
Operational FrequencyRange		$F_{nom}$			10.000000		MHz			
Clipped Sine Output Wave Start			Output Voltage Level	0.8			V			
	Output Load				10 // 10		K    pF			
	Start Time					2.0	ms	Milli-seconds		
Power Supply										
Voltage				3.135	3.3	3.465	V			
Supply Current	current load					2.0	mA			
Voltage Control										
Control Voltage				0.5		2.5	<b>V</b>			
Pulling Range				± 5.0			ppm			
Input Impedance				500			kΩ			
Frequency Stabilit										
Versus temperature	)		-40°C to +85°C	-1.5		+1.5	ppm			
Initial Accuracy				-1.0		+1.0	ppm			
Versus 5% change in supply voltage				-0.2		+0.2	ppm			
Versus load change				-0.2		+0.2	ppm			
Aging per year			First year @ 25°C	-1.0		+1.0	ppm			
			10 Hz		-91.0					
SSB Phase noise @ 10.000 MHz			100 Hz		-115.0		dBc/Hz			
			1000 Hz		-134.0		GDC/112			
			10000Hz		-148.0					
Environmental Co										
	Operating temperature range -40°C to +85°C									
Storage temperatur	e range	-55°C to +125°C								
Mechanical Shock		MIL-STD-883 Method 2002								
Mechanical Vibratio		MIL-STD-883 Method 2007								
Temperature Cycle										
Solderability		MIL-STD-883 Method 2003								
Fine and Gross Leak		MIL-STD-883 Method 1014								
Resistance to Solve	ents	MIL-ST	D-883 Method 2015							